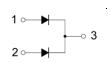


#### **Features**

- Average Rectified Output Current:I<sub>O</sub>=200 mA
- Power Dissipation of 225mw

# 3 2

## **SOT-23**



# **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
BAS21C	SOT-23	JS3	3000

# Maxmim Ratings (Ta=25 unless otherwise noted)

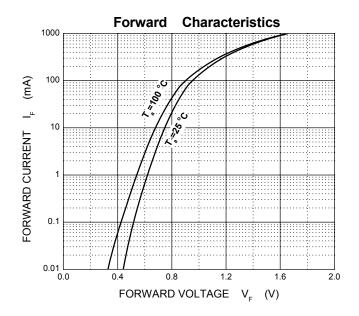
Parameter	Symbol	Limit	Unit
Repetitive peak reverse voltage	$V_{RRM}$		
Working peak reverse voltage	$V_{RWM}$	250	V
DC blocking voltage	$V_R$		
Forward continuous current	I <sub>FM</sub>	400	mA
Average rectified output current	Io	200	mA
Non-Repetitive Peak Forward Surge Current @t=8.3ms	I <sub>FSM</sub>	2.5	Α
Repetitive peak forward surge current	I <sub>FRM</sub>	625	mA
Power dissipation	P <sub>D</sub>	225	mW
Thermal resistance junction to ambient	$R_{\theta JA}$	555	°C/W
Junction temperature	TJ	150	°C
Storage temperature range	T <sub>STG</sub>	-55~+150	℃

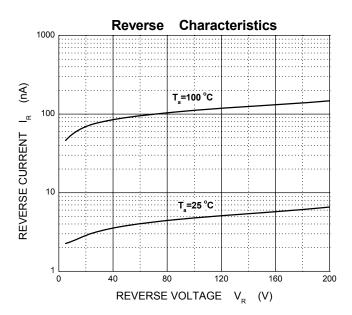
# Electrcal Charcteristics (Ta=25 unless otherwise specified)

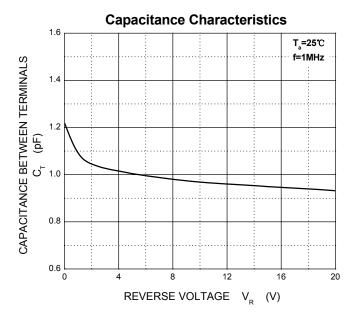
j					
Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	$V_{(BR)}$	I <sub>R</sub> = 100μA	250		V
Reverse voltage leakage current	I <sub>R</sub>	V <sub>R</sub> =200V		0.1	μΑ
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =100mA I <sub>F</sub> =200mA		1000 1250	mV
Diode capacitance	C <sub>D</sub>	V <sub>R</sub> =0V, f=1MHz		5	pF
Reveres recovery time	t <sub>rr</sub>	$I_F=I_R=30$ mA, $I_{rr}=0.1\times I_R$ , $R_L=100$ $\Omega$		50	ns

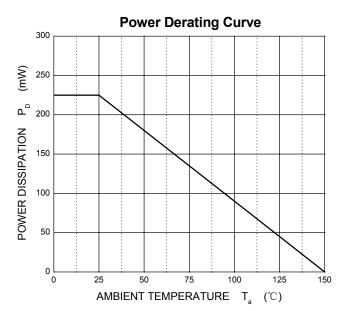


### **Typical Characteristics**

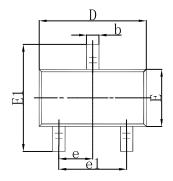


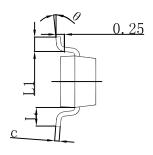


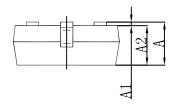




# **SOT-23 Package Outline Dimensions**

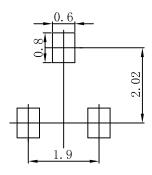






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# **SOT-23 Suggested Pad Layout**



- Note:
  1.Controlling dimension:in millimeters.
  2.General tolerance:±0.05mm.
  3.The pad layout is for reference purposes only.



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